SPECIFICATION FOR LCD MODULE

Model No. TM162EBAWG2

Prepared by:	Date:
Checked by :	Date:
Verified by :	Date:
Approved by:	Date:

TIANMA MICROELECTRONICS CO., LED

REVISION RECORD

Date	Ref. Page	Revision No.	Revision Items	Check & Approval

1 General Specifications:

1.1 Display type: STN/Yellow-Green

1.2 Display color*:

Display color: Blue-Black

Background: Yellow-Green

1.3 Polarizer mode: Reflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/16 Duty 1/5 Bias

1.6 Without Backlight

• Color tone is slightly changed by temperature and driving voltage.

1.7 Display Fonts: 5 x 7 dots(1 Character)

1.8 Data Transfer: 8 Bit Parallel

1.9 Front Polarizer: SHC-125U

Rear Polarizer: SHC-125M

1.10 Operating Temperature: −20----+70°C

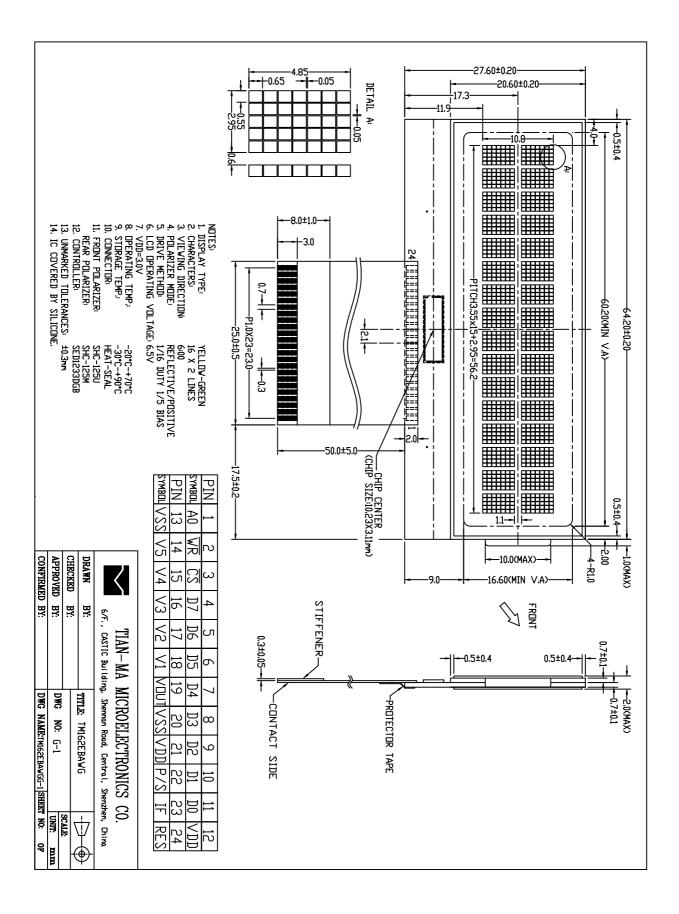
Storage Temperature: -30----+90°C

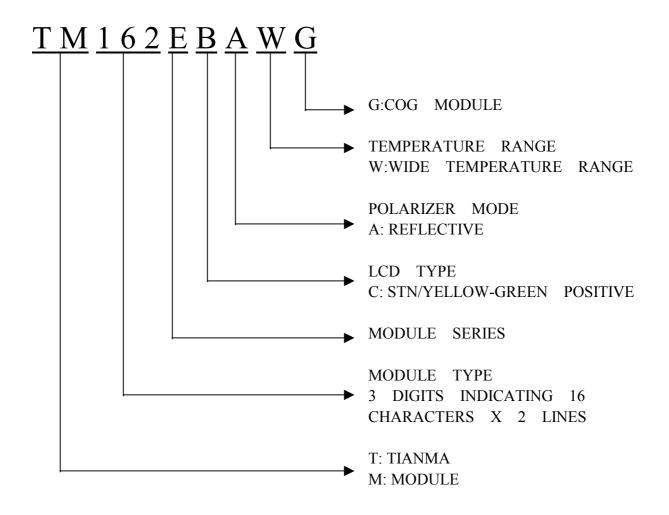
1.11 Outline Dimensions: Refer to outline drawing on next page

1.12 Dot Matrix: 16 Characters X 2

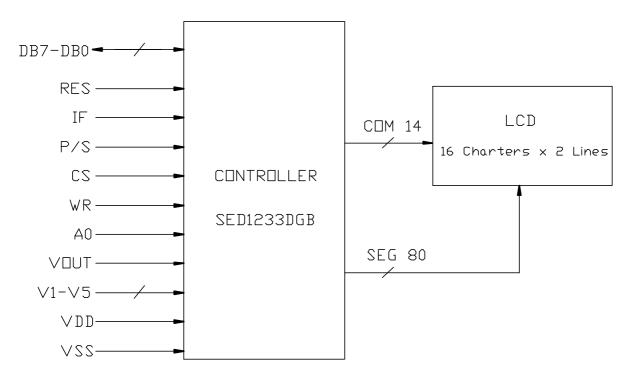
- 1.13 Dot Size: 0.55X0.65(mm)
- 1.14 Dot Pitch: 0.6X0.7 (mm)
- 1.15 Weight: 10g

2 Outline Drawing

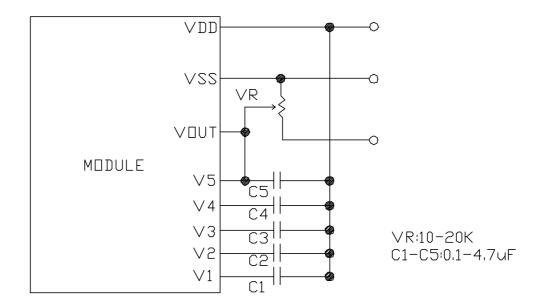




4 Circuit Block Diagram



Block Diagram Example of Power Supply



Both the boosting circuit and the voltage control circuit are not used in this module.

Therefore, connect V5 pin with Vout pin and supply the LCD driving voltage from the outside.

5 Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	Vdd-Vss	-0.3	6.0	v	
LCD Driving Voltage	VLCD	-0.3	13.0	v	
Operating Temperature Range	Тор	-20	+70	°C	No
Storage Temperature Range	Тѕт	-30	+90		Condensation

6 Electrical Specifications and Instruction Code

Iter	n	Symbol	Min.	Тур.	Max.	Unit
Supply V (Log	-	Vdd-Vss	2.4	2.4 3.0		V
Supply V (LCD E	-	VLCD	5.5	6.5	7.5	V
Input	High	V_{IH} (V _{DD} =3.0)	$0.7 \mathrm{V_{DD}}$	-	V _{DD} +0.3	V
Signal Voltage	Low	V _{IL} (V _{DD} =3.0)	-0.3	-	0.2 V _{DD}	V
Supply current (Logic)		I_{DD} (VDD-VSS=3.0)	-	50	100	uA

6.1 Electrical characteristics

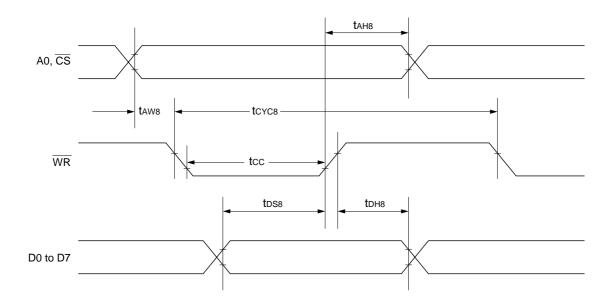
6.2 Interface Signals

Pin No.	Symbol	Level	Description						
1	A0	H/L	H:D0-D7 are display data						
			L:D0-D7 are controller command						
2	WR	H/L	80 family MPU: WR Signal Input L: Active						
	, , , , , , , , , , , , , , , , , , ,		68 family MPU:Enable clock	k input					
3	CS	H/L	Chip selects signal L:Activ	7e					
4	D7	H/L	Data Bus Line						
5	D6	H/L	Data Bus Line						
6	D5	H/L	Data Bus Line						
7	D4	H/L	Data Bus Line						
8	D3	H/L	Data Bus Line	Noconnection					
9	D2	H/L	Data Bus Line	at 4-bit operation					
10	D1	H/L	Data Bus Line						
11	D0	H/L	Data Bus Line						
12	Vdd	3.0V	Supply Voltage						
13	Vss	0V	Ground						
14	V5	-	Connect to Vdd and a capaci	tor of 0.1-4.7 uF					
15	V4	-	Connect to a capacitor of 0.1	−4.7 uF					
16	V3	-	Connect to a capacitor of 0.1	—4.7 uF					
17	V2	-	Connect to a capacitor of 0.1	—4.7 uF					
18	V1	-	Connect to a capacitor of 0.1	—4.7 uF					
19	Vout	-	Supply Voltage(LCD Drive)						
20	Vss	-	Ground						
21	Vdd	-	Supply Voltage (+3.0V)						
22	P/S	H/L	H:Parallel Data Transfer L	:Serial Data Transfer					
23	IF	H/L	Interface Data Length Select H:8-bits Parallel L:4-bit Parallel						
24	RES	H/L	Reset Signal						

6.3 Interface Timing Chart

TIMING CHARACTERISTICS

(1) System Bus Write Characteristic I (80 series MPU)

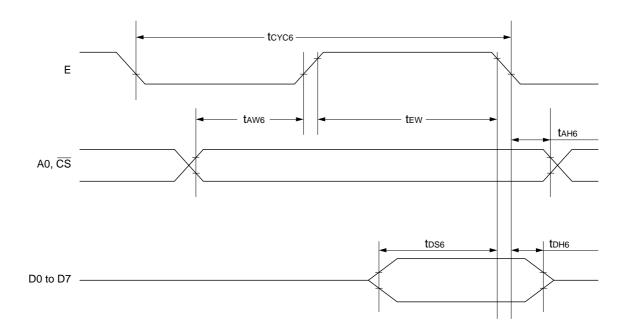


Item	Signal	Symbol	Measuring condition	Min.	Max.	Unit
Address hold time	A0, CS	t AH8		30		ns
Address setup time		t AW8		60		ns
System cycle time	WR	t CYC8	Vss = -3.0	500		ns
			-2.7	550		
			-2.4	650		
Control pulse width (WR)		t cc	Vss = -3.0	100		ns
			-2.7	120		
			-2.4	150		
Data setup time	D0 ~ D7	t DS8		100		ns
Data hold time		t DH8		50		ns

*1: For the rise and fall of an input signal, set a value not exceeding 25 ns. *2: Every timing is specified on the basis of 20% and 80% of Vss.

*3: For A0 and \overline{CS} , the same time is not required. Input signals so that A0 and \overline{CS} may satisfy tAW8 and tAH8 respectively.

(2) System Bus Write Characteristic II (68 series MPU)



ltem	Signal	Symbol	Measuring condition	Min.	Max.	Unit
System cycle time	A0, <u>CS</u>	t CYC6	Vss = -3.0	500		ns
			-2.7	550		
			-2.4	650		
Address setup time		t AW6		60		
Address hold time		t AH6		30		ns
Data setup time	D0 ~ D7	t DS6		100		ns
Data hold time		t DH6		50		ns
Enable pulse width	E	t ew	Vss = -3.0	100		ns
			-2.7	120		
			-2.4	150		

[Vss = -3.6 V to -2.4 V, Ta = -30 to 85° C unless otherwise specified]

*1: tCYC6 denotes the cycle of the E signal in the $\overline{\text{CS}}$ active state. tCYC6 must be reserved after $\overline{\text{CS}}$ becomes active. *2: For the rise and fall of an input signal, set a value not exceeding 25 ns.

*3: Every timing is specified on the basis of 20% and 80% of Vss.

*4: For A0 and \overline{CS} , the same timing is not required. Input signals so that A0 and \overline{CS} may satisfy tAW6 and tAH6 respectively.

6.4 Instruction Code

Command					Co	de					Function	
Command	A0	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function	
(1) Cursor Home	0	0	0	0	0	1	*	*	*	*	Moves the cursor to the home position.	
(2) Static Display Control	0	0	0	0	1	0	*	*	SD S	1 D0	Sets the display mode of static display symbol SD1, SD0 = 0, 0 (display OFF), 0, 1 (1 - 2 Hz blink), 1, 0 (3 4 Hz blink), 1, 1 (all display ON)	
(3) Display ON/OFF Control	0	0	0	0	1	1	С	В	DC	D	Sets cursor ON/OFF (C), cursor blink ON//OFF (B), double cursor ON/OFF (DC) and display ON/OFF (D). C = 1 (cursor ON) 0 (cursor OFF), B = 1 (blink ON) 0 (blink OFF) DC = 1 (double cursor ON) 0 (double cursor OFF), D = 1 (display ON) D = 0 (display OFF)	
(4) Power Save	0	0	0	1	0	0	*	*	0	PS	Sets power save ON/OFF (PS) and oscillating circuit ON/OFF (0). PS = 1 (power save ON) 0 (power save OFF), 0 = 1 (oscillating circuit ON) 0 (oscillating circuit OFF)	
(5) Power Control	0	0	0	1	0	1	0	VC	VF	Р	Sets voltage regulating circuit ON/OFF and boosting circuit ON/OFF (P). VC = 1 (voltage regulating circuit ON) 0 (voltage regulating circuit OFF) VF = 1 (voltage follower ON) 0 (voltage follower OFF), P = 1 (boosting circuit ON) 0 (boosting circuit OFF)	
(6) System Set	0	0	0	1	1	0	N2	N1	*	CG	Sets the use or non-use of CG RAM and display lines (N2, N1). CG = 1 (use of CG RAM) 0 (non-use of CG RAM), N2, N1 = 0, 0 (2 lines) 0, 1 (3 lines) 1, 0 (4 lines)	
(7) Electronic Volume Register	0	0	0	1	1	1	MS	SB	L	SB	Sets the electronic volume register value.	
(8) RAM Address Set	0	0	1			AD	DRI	ESS			Sets the DD RAM, CG RAM or symbol register address.	
(9) RAM Write	1	0				DA	TA				Writes data into the DD RAM, CG RAM or symbol register address.	

		0	1	2	3	4	5	6	ower 4 E 7	Bit of Coc 8	le 9	A	В	С	D	E	F
	0																
	1																
	2																
	3																
	4																
	5																
	6																
Higher 4 Bit of Cord	7																
Higher 4	8																
	9																
	A																
	в																
	с																
	D																
	E																
	F																

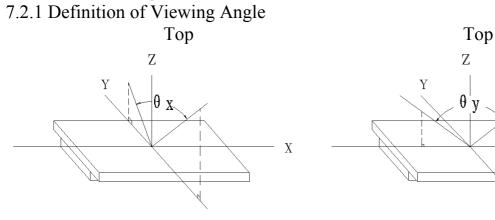
7 Optical Characteristics

7.1 Optical Characteristics

Ta=25℃

	Iu 2	250						
Item	L	Symbol	Con	dition	Min.	Тур.	Max.	Unit
Viewing Angle		$\theta_{\mathbf{x}}$	Cr≥2	$\theta_y=0^{\circ}$	-35		20	Dog
		θγ	Cr≥2	θ _x =0°	-30)	30	Deg
Contrast]	Contrast Ratio		$\theta_{x}=0^{\circ}$ $\theta_{y}=0^{\circ}$		4	-	-	
Response	Turn on	Ton	$\theta_x = 0^\circ$ $\theta_y = 0^\circ$		-	-	250	
Time	Turn off	Toff	θy=	=0°	-	-	250	ms

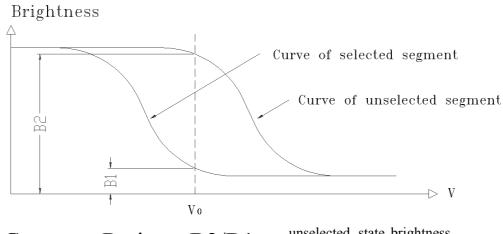
7.2 Definition of Optical Characteristics





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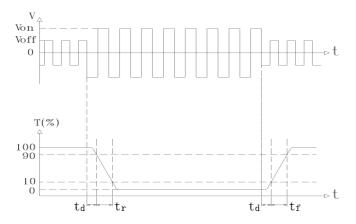






Measuring Conditions:

1) Frame frequency: 100.0Hz 7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$ Tur Measuring Condition: 1) Operating Voltage: 6.5V

Turn off time: $t_{off} = t_d + t_f$

2) Frame frequency: 100.0Hz

8 Reliability

8.1 E	nvironmental Test	Ta=25℃	
No.	Test Item	Content of Test	Test condition
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	85℃ 240H
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30°C 240H
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	70℃ 240H
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	-20℃ 240H
5	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	60°C 95%RH 240H 80°C 95%RH 48H (Non condensation)
6	Temperature Cycle	Endurance test applying the low and high temperature cycle $-30^{\circ}C \longrightarrow 25^{\circ}C \longrightarrow 90^{\circ}C \longrightarrow 25^{\circ}C$ <u>30min 5min 30min 5min</u> \rightarrow 1 cycle	-30℃/90℃ 10 cycles
7	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~500Hz, 100m/s ² , 120min
8	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 300m/s ² , 18ms
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	25kPa 16H

8.2 Failure Judgment Criterion

Criterion			Te	est	Iter	n N	0.			Failura Indeamont Critarian
Item	1	2	3	4	5	6	7	8	9	Failure Judgement Criterion
Basic Specification				\checkmark				\checkmark	\checkmark	Out of the basic Specification
Electrical specification										Out of the electrical specification
Mechanical Specification								\checkmark		Out of the mechanical specification
Optical Characteristic									\checkmark	Out of the optical specification
Note	For test item refer to 8.1									
Remark	Basic specification = Optical specification + Mechanical specification									

9 QUALITY LEVEL

Examination	At T _{amb} =25°C	Inspection					
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL	
External Visual Inspection	Under normal illumi-nation and eyesight condition, the dis-tance between eyes and LCD is 25cm.	See ann	lex A		II	Major 0.4 Minor 0.65	
Display Defects	Undernormalillumi-nationandeyesightcondition,display on inspection.	See ann	lex B		II	Major 0.4 Minor 0.65	
Note: Major defects: Open segment or common, Short, Serious damages, Leakage Miner defects: Others Sampling standard conforms to GB2828							

10 Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature :0°C $\sim 40°C$ Relatively humidity: $\leq 80\%$

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Annex A

Inspection items and criteria for appearance defects

Items	Contents	Critera				
Protective Glue	No clear defects					
Cover Tape	Covering all of the chip and no clear crimple					
Leakage	Not permitted	Not permitted				
Rainbow		Accoding to th	ne	limit specimen		
	Wrong polarizer attachment		Not permitted			
Polarizer	Bubble between	not counted		Max. 3 defect allowed		
	polarizer and glass	ø<0.3mm	0.3mm≤ø≤0.5		mm	
	Scratches of polarizer	Accoding to the limit specimen				
		not counted	Max. 3 spots allowed			
Black spot (in viewing		X<0.20mm	0.20mm ≼ X ≼ 0.5mm		Max. 3	
area)		X=(a+b)/2			spots	
Black line		not counted	Max. 3 lines allowed		-(lines) allowed	
(in viewing area)		a<0.02mm	0.02mm≼a≼0.05mm b≼2.0mm			
Progressive cracks		Not permitted				

Annex A

Increation items and	critoria for appoarant	ce defects (continued)
inspection nems and		
1	11	

Items	Contents			Critera		
	cracks on pads	a	b	с		
	W V	<3mm	≪W/5	5 ≼T/2	 	
		<3mm	≪W/5	5 >T/2	cracks allowed	
	cracks on contact side	a		b		_
		≼ 3m	m	≼T/2		Max. 5
Glass Cracks		≤2m	m	T/2 <b<t< td=""><td></td><td>cracks allowed</td></b<t<>		cracks allowed
		c shall be not reach the seal area			Max. 2	anowed
	cracks on non-contact side	a		b	cracks allowed	
		≼ 3mm		≼T/2		
		≤2mm		T/2 <b<t< td=""><td></td></b<t<>		
	E	¢≼0.5mi	n			
		d≼sw/3				
	Corner cracks	e<2.0mn f<2.0mm			Max. 3 cracks allowed	

Annex B

Inspection items and criteria for display defects

ltems	Contents	Critera				
Open segment or open common		Not permitted				
short		Not permitted				
Wrong viewing angle		Not permitted				
Contrast radi	o uneven	According to	the limit specimen			
Crosstalk		According to	the limit specimen			
	-1 1-a	Not counted	Max. 3 dots allowed	_		
		X<0.1mm	0.1mm≼X≼0.2mm			
Pin holes		X=(a+b)/2	Max. 3 dots			
and cracks in segment		Not counted	Max. 2 dots allowed	allowed		
(DOT)	T T	A<0.1mm	0.1mm≼A≼0.2mm D<0.25mm			
		Not counted	Max. 3 spots allowed			
Black spot (in viewing		X<0.1mm	0.1mm≼X≼0.2mm			
area))		X=(a+b)/2	Max. 3 spots			
Black line	L	Not counted	Max. 3 lines allowed	(lines) allowed		
(in viewing area)	tb	a<0.02mm	0.02mm≼a≼0.05mm b≼0.5mm			

Annex B

Inspection items and criteria for display defects (continued)

Items	Contents		Critera			
	-11-a	Not counted	Max. 2 defects allowed			
		X<0.1mm	0.1mm≼X≼0.20mm			
		X=(a+b)/2	Max. 3			
		Not counted	Max. 1 defects allowed	defects allowed		
Transfor— mation of segment		a<0.1mm	0.1mm≼a≼0.20mm D>0			
		Max. 2 defects allowed 0.8W≼a≼1.2W				
		a=measured value of width W=nominal value of width				